

Intel Core i9-13900KF (24C, 3.00GHz, 36MB, tray



✓ 1 Stück ab Lager verfügbar (Lieferzeit ca. 1-3 Arbeitstage)

Listenpreis:

~~CHF 657.20~~

Du sparst bei Orderflow::

CHF -114.50

CHF **542.70**

INTEL Core i9-13900KF 3.0GHz LGA1700 Tra

- INTEL Core i9-13900KF 3.0GHz LGA1700 36M Cache Tray CPU

Hersteller	Intel
EAN	8592978411251
Hersteller-Nr	CM8071505094012
Markiert als	Neu

Beschreibung

Performance weitergedacht.

Spezifikation

Produktbeschreibung	Intel Core i9 13900KF / 3 GHz Prozessor - OEM
Produkttyp	Prozessor
Prozessortyp	Intel Core i9 13900KF (13th Gen)
Anz. der Kerne	24 Kerne / 32 Threads
Cache-Speicher	36 MB
Geeignete Sockel	LGA1700 Socket
Prozessoranz.	1
Taktfrequenz	3 GHz
Max. Turbo-Taktfrequenz	5.8 GHz
Herstellungsprozess	7 nm

Funktionen	Enhanced SpeedStep technology, Hyper-Threading-Technologie, Unterstützung für Execute Disable Bit, Intel Virtualization Technology, Intel 64 Technology, Streaming-SIMD-Erweiterungen 4.1, Streaming-SIMD-Erweiterungen 4.2, Intel Turbo Boost Technology 2.0, Intel AES New Instructions (AES-NI), Thermal Monitoring Technologies, Intel Virtualization Technology for Directed I/O (VT-d), Idle States, Intel VT-x with Extended Page Tables (EPT), Intel Secure Key, Intel Advanced Vector Extensions 2 (AVX2.0), Intel OS Guard, Intel Turbo Boost Max Technology 3.0, Intel Speed Shift Technology, Mode-based Execute Control (MBE), Intel Volume Management Device (VMD), Intel Boot Guard, Intel Thermal Velocity Boost, Intel Deep Learning Boost (DL Boost), Intel Control-Flow Enforcement Technology, Intel Gaussian and Neural Accelerator 3.0, Intel Thread Director, Instruction Set 64-bit, Intel Standard Manageability (ISM)
Herstellergarantie	1 Jahr Garantie

Tech. Details

Produkttyp	Prozessor
Typ / Formfaktor	Intel Core i9 13900KF (13th Gen)
Anz. der Kerne	24 Kerne
Anz. der Threads	32 Threads
Cache-Speicher	36 MB
Cache-Speicher-Details	Smart Cache - 36 MB L2 - 32 KB
Prozessoranz.	1
Taktfrequenz	3 GHz
Max. Turbo-Taktfrequenz	5.8 GHz
Geeignete Sockel	LGA1700 Socket
Herstellungsprozess	7 nm
Thermal Design Power (TDP)	253 W
Temperaturspezifikationen	100 °C
PCI Express Revision	4.0/5.0
PCI Express-Konfigurationen	1x16+4, 2x8+4
Anz. PCI Express Lanes	20
Architektur-Merkmale	Enhanced SpeedStep technology, Hyper-Threading-Technologie, Unterstützung für Execute Disable Bit, Intel Virtualization Technology, Intel 64 Technology, Streaming-SIMD-Erweiterungen 4.1, Streaming-SIMD-Erweiterungen 4.2, Intel Turbo Boost

Technology 2.0, Intel AES New Instructions (AES-NI), Thermal Monitoring Technologies, Intel Virtualization Technology for Directed I/O (VT-d), Idle States, Intel VT-x with Extended Page Tables (EPT), Intel Secure Key, Intel Advanced Vector Extensions 2 (AVX2.0), Intel OS Guard, Intel Turbo Boost Max Technology 3.0, Intel Speed Shift Technology, Mode-based Execute Control (MBE), Intel Volume Management Device (VMD), Intel Boot Guard, Intel Thermal Velocity Boost, Intel Deep Learning Boost (DL Boost), Intel Control-Flow Enforcement Technology, Intel Gaussian and Neural Accelerator 3.0, Intel Thread Director, Instruction Set 64-bit, Intel Standard Manageability (ISM)

Verpackung

OEM/Tray

Service und Support

Begrenzte Garantie - 1 Jahr

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